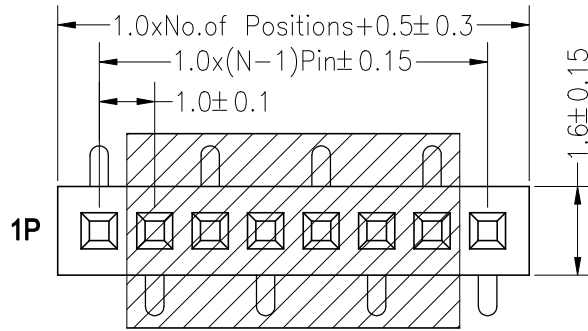




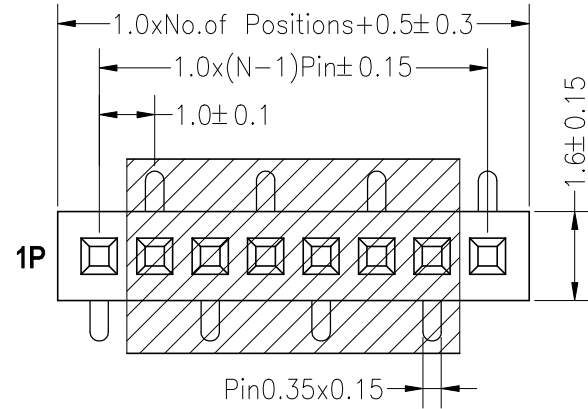
**SPECIFICATIONS**

Rated Current:0.75AMP  
 Contact Resistance:30mΩ Max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Max.Processing Temp: 230°C for 30-60 seconds  
 (260°C for 10 seconds)

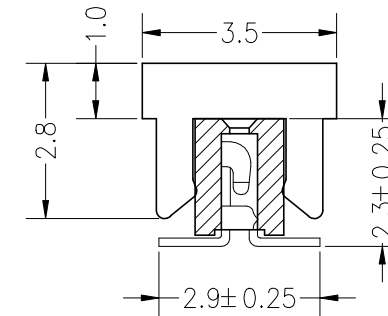
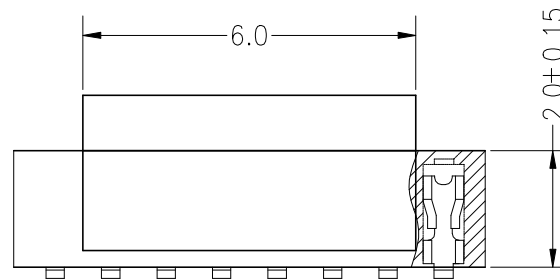
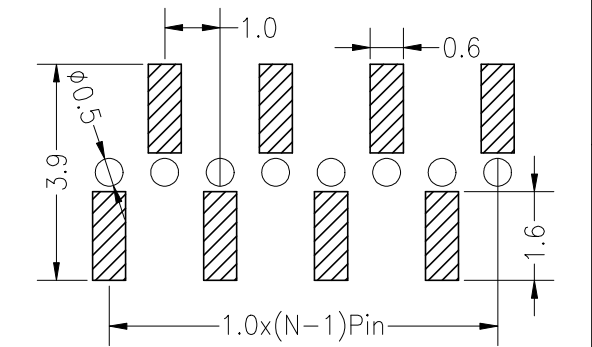
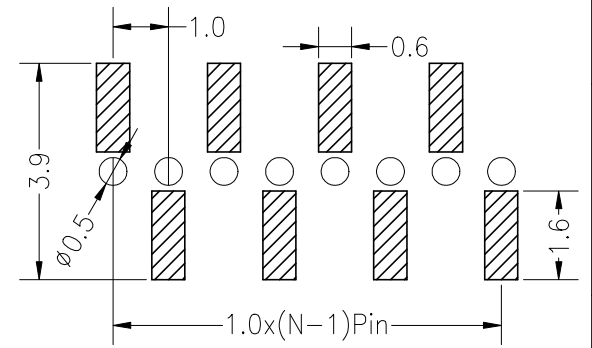


TYPE02



TYPE01

**Recommended P.C.B Layout(Top Side)**  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

2620 01 XX X N XX M U X 0X

No.of Pins Per Row  
1~1~1~50

Insulator Material Option  
 A=BK-PBT  
 B=BK-PA66  
 C=BK-PA6T  
 D=BK-PA46  
 E=BK-PA9T  
 F=BK-LCP

Contact Plating  
 G1:Gold Flash  
 G2:1.5U" Gold  
 G3:2U" Gold  
 G4:3U" Gold  
 G5:5U" Gold  
 S0:Gold Flash/Tin  
 SN:Tin

Packing  
 O=PE Bag  
 A=Tray  
 T=Tube  
 P=Tube+Cap  
 R=Reel+Cap  
 M=Reel+Mylar

OPERATION		DRAW	Liu Miao	19.09.30
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

**WFD** 深圳市旺富达电子有限公司  
 CONN SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO. 262001XXXXXXMUXOX  
 TITLE: 1.0PF H2.0mm 1XNP SMT

A0	2019.09.30	NEW DRAWING	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE